

# **CMOS Expandable 4-Wide** 2-Input AND-OR-INVERT Gate

High-Voltage Types (20-Volt Rating)

CD4086B contains one 4-wide 2-input AND-OR-INVERT gate with an INHIBIT/EXP input and an ENABLE/ EXP input. For a 4-wide A-O-I function INHIBIT/ $\overline{\text{EXP}}$  is tied to  $\text{V}_{\text{SS}}$  and ENABLE/EXP to VDD. See Fig.10 and its associated explanation for applications where a capability greater than 4-wide is required.

The CD4086B types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

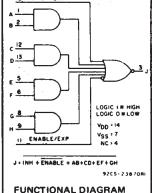
MAXIMUM RATINGS, Absolute-Maximum Values:

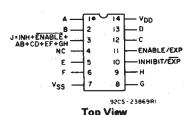
#### Features:

- Medium-speed operation tpHL = 90 ns; tpLH = 140 ns (typ.) at 10 V
- **INHIBIT and ENABLE inputs**
- **Buffered** outputs
- 100% tested for quiescent current at 20 V
  - Maximum input leakage current of 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package termperature range):

- 2.5 V at VDD v Standardized, symmetrical output
- characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"







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COMMERCIAL CMOS HIGH VOLTAGE ICs

**TERMINAL ASSIGNMENT** 

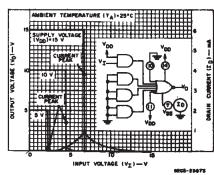


Fig. 1 - Typical voltage and current transfer characteristics.

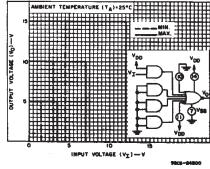


Fig. 2 - Minimum and maximum voltage transfer characteristics.

#### DC SUPPLY-VOLTAGE RANGE, (VDD) Voltages referenced to V<sub>SS</sub> Terminal) .....-0.5V to +20V POWER DISSIPATION PER PACKAGE (PD): For T<sub>A</sub> = +100°C to +125°C.....Derate Linearity at 12mW/°C to 200mW DEVICE DISSIPATION PER OUTPUT TRANSISTOR OPERATING-TEMPERATURE RANGE (TA)......-55°C to +125°C STORAGE TEMPERATURE RANGE (Tsto).....-65°C to +150°C LEAD TEMPERATURE (DURING SOLDERING):

### **RECOMMENDED OPERATING CONDITIONS**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

	LIN		
CHARACTERISTIC	MIN.	MAX.	UNITS
Supply-Voltage Range (For T <sub>A</sub> = Full Package- Temperature Range)	3	18	v

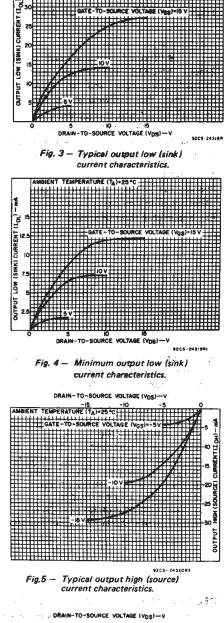
### CD4086B Types

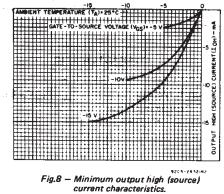
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### STATIC ELECTRICAL CHARACTERISTICS

CHARAC- TERISTIC	CONDITIONS        Vo      VIN      Vpp        (V)      (V)      (V)			VDD					MPERATURES (°C) +25 Min. Typ. Max.			
Quiescent	_	0,5	5	1	1	30	30		0.02	1	· · · · ·	
Device		0,10	10	2	2	60	60		0.02	2		
Current		0,15	15	4	4	120	120		0.02	4	μA	
IDD Max.	-	0,20	20	20	20	600	600	_	0.02	20		
Output Low					· · · ·					<u>, « – – ,                               </u>		
(Sink)	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	3613 <b>1</b>			
Current,	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-		
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1		mA	
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2			
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_		
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	- ·		
Output Volt-							:					
age:	- 1	0,5	5		0.0	)5		_	0	0.05		
Low-Level,		0,10	10		,0.0	)5			0	0.05		
V <sub>OL</sub> Max.		0,15	15		0.0	) <b>5</b> - <sub>2</sub> - 2-	, <u>,</u>		Q	0.05		
Output Volt-		F.4.1							-		V	
age:		0,5	5		4.9	)5		4.95	5	_		
High-Level,	-	0,10	10		9.9	95		9.95	10	_		
V <sub>OH</sub> Min.	. —	0,15	15		14.	95		14.95	15	-		
Input Low	0.5,4.5	-	5		1.	5		_	_	1.5		
Voltage,	1,9	-	10		3			_	-	3		
VIL Max.	1.5,13.5	-	15		4				_	4		
Input High	0.5,4.5	-	5		3.	5		3.5	_		V	
Voltage,	1,9	<u> </u>	10		7			7	_	_		
VIH Min.	1.5,13.5	+	15	11				11	-			
Input Current, I <sub>IN</sub> Max.		0,18	18	±0.1	±0.1	±1	_±1		±10-5	±0.1	μΑ	





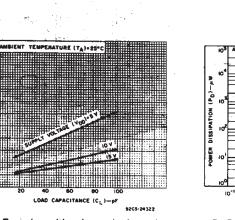
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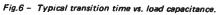
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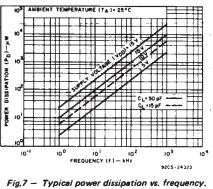
THL

TIME (1)

ğ







12.1

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## CD4086B Types

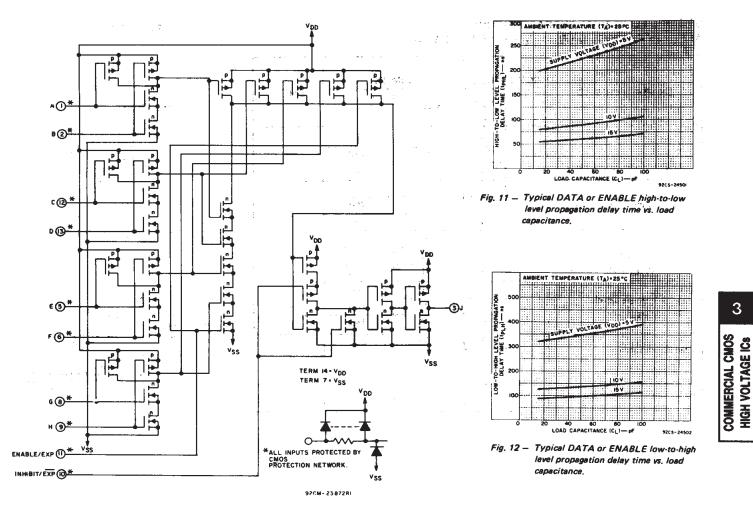


Fig. 9 - CD4086B schematic diagram.

VSS A2

82

cz

D2 E2

F2

G 2

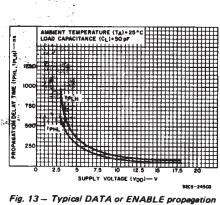
н2

9205-23871

ENABLE / EXP;

J2-AIBI+CI DI+EI FI+GI HI + A2 82+C2 D2+E2 F2+G2 H2

Fig. 10 - Two CD4086B's connected as an 8-wide 2-input A-O-I gate.



3

delay time vs. supply voltage.

Fig. 10 above shows two CD4086's utilized to obtain an 8-wide 2-input A-O-I function. The output (J1) of one CD4086 is fed directly to the ENABLE/EXP2 line of the second CD4086. In a similar fashion, any

INHIBIT/EXP

AI

81

cı D1

ΕI FI

GI

ы

ENAULE/EXP

vod

NAND gate output can be fed directly into the ENABLE/EXP input to obtain a 5-wide A-O-I function. In addition, any AND gate output can be fed directly into the IN-HIBIT/EXP input with the same result.

### DYNAMIC ELECTRICAL CHARACTERISTICS

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At  $T_A = 25^{\circ}C$ ; Input  $t_r$ ,  $t_f = 20$  ns,  $C_L = 50$  pF,  $R_L = 200$  k $\Omega$ 

	CONDI	TIONS	LI		
CHARACTERISTIC		V <sub>DD</sub> (V)	ТҮР.	MAX.	UNITS
Propagation Delay Time		5	225	450	
(Data):		10	90	180	ns
High-to-Low Level, tpHL		15	60	120	
Low-to-High Level, t <sub>PLH</sub>		5	310	620	
		10	125	250	ns
		15	90	180	1
Propagation Delay Time		5	150	300	
(Inhibit): High-to-Low		10	60	120	s ns
Level, tPHL(INH)		15	40	80	1
Level en Historia et		5	250	500	
Low-to-High Level,		10	100	200	ns
<sup>t</sup> PLH(INH)		15	70	140	1
Transition Time		5	100	200	
Transition Time,		10	50	100	ns
THL <sup>, T</sup> TLH		15	40	80	]
Input Capacitance CIN	Any	Input	5	7.5	pF

**TEST CIRCUITS** 

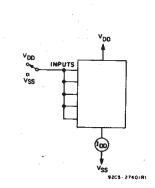


Fig. 14 - Quiescent device current,

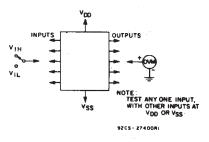
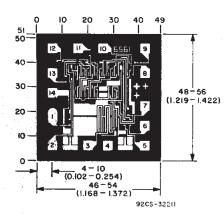


Fig. 15 - Input voltage.



4.0

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \text{ inch})$ .

Dimensions and Pad Layout for the CD4086BH

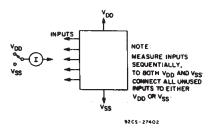


Fig. 16 - Input leakage current.

in in inge



24-Aug-2018

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
CD4086BE	ACTIVE	PDIP	Ν	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-55 to 125	CD4086BE	Samples
CD4086BF3A	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	CD4086BF3A	Samples
CD4086BM	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4086BM	Samples
CD4086BMT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4086BM	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD4086B, CD4086B-MIL :

• Catalog: CD4086B

• Military: CD4086B-MIL

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

w

(mm)

16.0

Pin1

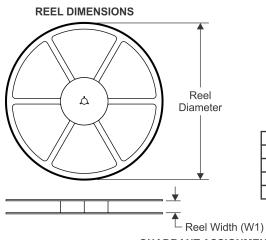
Quadrant

Q1

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Texas Instruments

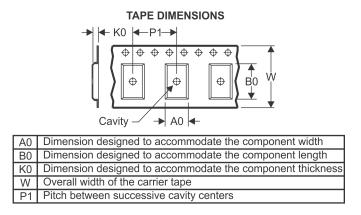
## TAPE AND REEL INFORMATION



CD4086BMT

SOIC

D



## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



330.0

16.4

6.5

9.0

2.1

8.0

*All dimensions are nominal									
Device	•	Package Drawing		Reel Diameter (mm)	Reel Width W1 (mm)	· · ·	B0 (mm)	K0 (mm)	P1 (mm)

250

14

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

8-Nov-2018



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4086BMT	SOIC	D	14	250	210.0	185.0	35.0

# **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



# J0014A

# **EXAMPLE BOARD LAYOUT**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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